2SK1762

Silicon N-Channel MOS FET

HITACHI

ADE-208-1316 (Z)
1st. Edition
Mar. 2001

Application

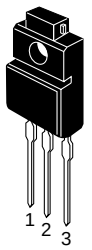
High speed power switching

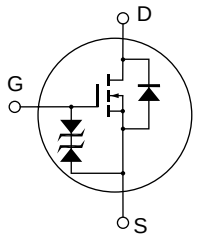
Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switchingregulator, DC-DC converter

Outline

TO-220FM





1. Gate
2. Drain
3. Source

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Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	250	V
Gate to source voltage	V_{GSS}	±30	V
Drain current	I_D	12	A
Drain peak current	$I_{D(pulse)}$*[1]	48	A
Body to drain diode reverse drain current	I_{DR}	12	A
Channel dissipation	Pch*[2]	35	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	–55 to +150	°C

Notes 1. PW 10 µs, duty cycle 1 %
2. Value at Tc = 25 °C

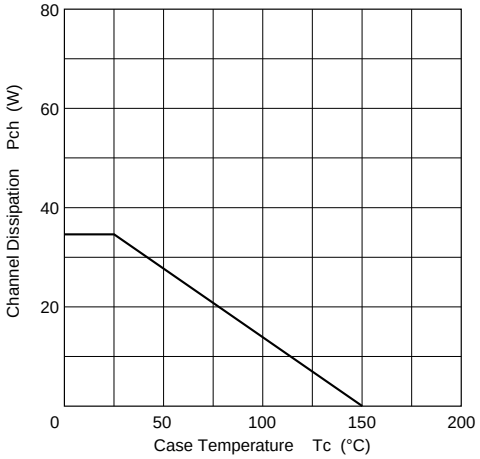
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	250	—	—	V	I_D = 10 mA, V_{GS} = 0
Gate to source breakdown voltage	$V_{(BR)GSS}$	±30	—	—	V	I_G = ±100 µA, V_{DS} = 0
Gate to source leak current	I_{GSS}	—	—	±10	µA	V_{GS} = ±25 V, V_{DS} = 0
Zero gate voltage drain current	I_{DSS}	—	—	250	µA	V_{DS} = 200 V, V_{GS} = 0
Gate to source cutoff voltage	$V_{GS(off)}$	2.0	—	3.0	V	I_D = 1 mA, V_{DS} = 10 V
Static drain to source on state resistance	$R_{DS(on)}$	—	0.23	0.35		I_D = 6 A V_{GS} = 10 V*[1]
Forward transfer admittance	$\|y_{fs}\|$	5.0	8.0	—	S	I_D = 6 A V_{DS} = 10 V*[1]
Input capacitance	Ciss	—	1100	—	pF	V_{DS} = 10 V
Output capacitance	Coss	—	440	—	pF	V_{GS} = 0
Reverse transfer capacitance	Crss	—	68	—	pF	f = 1 MHz
Turn-on delay time	$t_{d(on)}$	—	20	—	ns	I_D = 6 A
Rise time	t_r	—	65	—	ns	V_{GS} = 10 V
Turn-off delay time	$t_{d(off)}$	—	100	—	ns	R_L = 5
Fall time	t_f	—	44	—	ns	
Body to drain diode forward voltage	V_{DF}	—	1.0	—	V	I_F = 12 A, V_{GS} = 0
Body to drain diode reverse recovery time	t_{rr}	—	200	—	ns	I_F = 12 A, V_{GS} = 0, di_F / dt = 100 A / µs

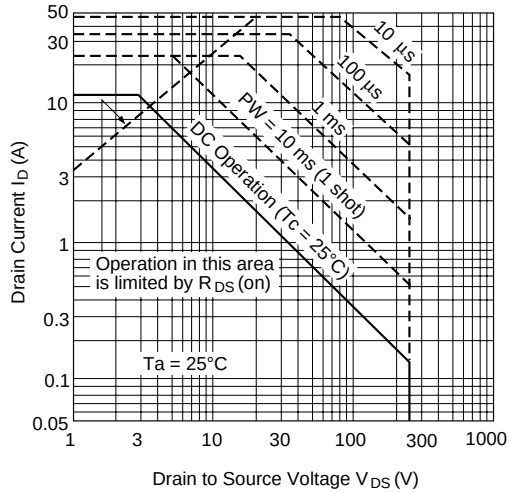
Note 1. Pulse Test

See characteristic curves of 2SK1761.

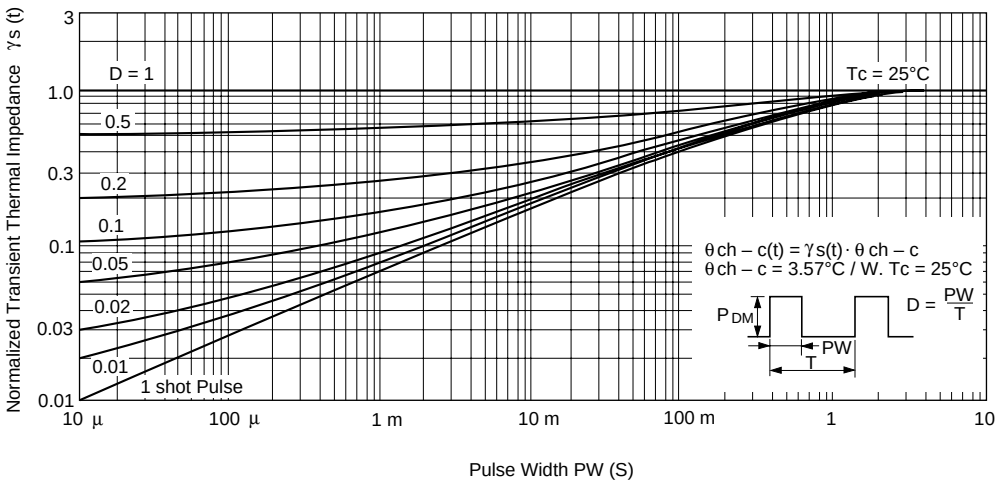
Power vs. Temperature Derating



Maximum Safe Operation Area



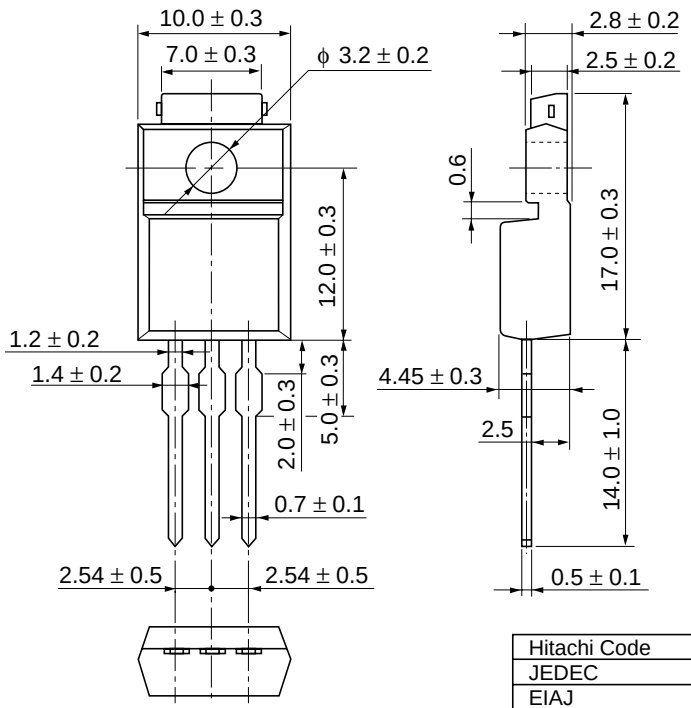
Normalized Transient Thermal Impedance vs. Pulse Width

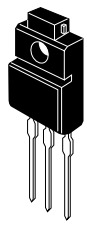


Package Dimensions

As of January, 2001

Unit: mm





Hitachi Code	TO-220FM
JEDEC	—
EIAJ	Conforms
Mass (reference value)	1.8 g

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